DATA SHEET

PCF8593

Low power clock calendar

Product specification

Supersedes data of June 1994

File under Integrated Circuits, IC12

July 1994

Philips Semiconductors

PHILIPS

Low power clock calendar   PCF8593

FEATURES

- I^2C-bus interface operating supply voltage: 2.5 to 6.0 V
- Clock operating supply voltage (T_{amb} = 0 to +70 °C): 1.0 to 6.0 V
- Data retention voltage: 1.0 to 6.0 V
- External $\overline{RESET}$ input pin
- Operating current (f_{scl} = 0 Hz, 32 kHz time base, V_{DD} = 2.0 V): typ. 1 μA
- Clock function with four year calendar
- Universal timer with alarm and overflow indication
- 24 or 12 hour format
- 32.768 kHz or 50 Hz time base
- Serial input/output bus (I^2C-bus)
- Automatic word address incrementing
- Programmable alarm, timer and interrupt function
- Space-saving SO8 package
- Slave address:
  - READ A3H
  - WRITE A2H.

GENERAL DESCRIPTION

The PCF8593 is a CMOS Real-time clock/calendar optimized for low power consumption. Addresses and data are transferred serially via a two-line bidirectional bus (I^2C-bus). The built-in word address register is incremented automatically after each written or read data byte. The built-in 32.768 kHz oscillator circuit and the first 8 registers are used for the clock/calendar and counter functions. The next 8 registers may be programmed as alarm registers or used as free RAM space.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V_{DD}	supply voltage operating mode	I^2C-bus active	2.5	6.0	V
		I^2C-bus inactive	1.0	6.0	V
I_{DD}	supply current operating mode	f_{scl} = 100 kHz	–	200	μA
I_{DD}	supply current clock mode	f_{scl} = 0 Hz; V_{DD} = 5 V	4.0	15.0	μA
		f_{scl} = 0 Hz; V_{DD} = 2 V	1.0	8.0	μA
T_{amb}	operating ambient temperature		–40	+85	°C
T_{stg}	storage temperature		–65	+150	°C

ORDERING INFORMATION

TYPE NUMBER	PACKAGE			
	PINS	**PIN POSITION**	**MATERIAL**	**CODE**
PCF8593P	8	DIL	plastic	SOT97-1
PCF8593T	8	SO8	plastic	SOT96-1

Low power clock calendar   PCF8593

BLOCK DIAGRAM
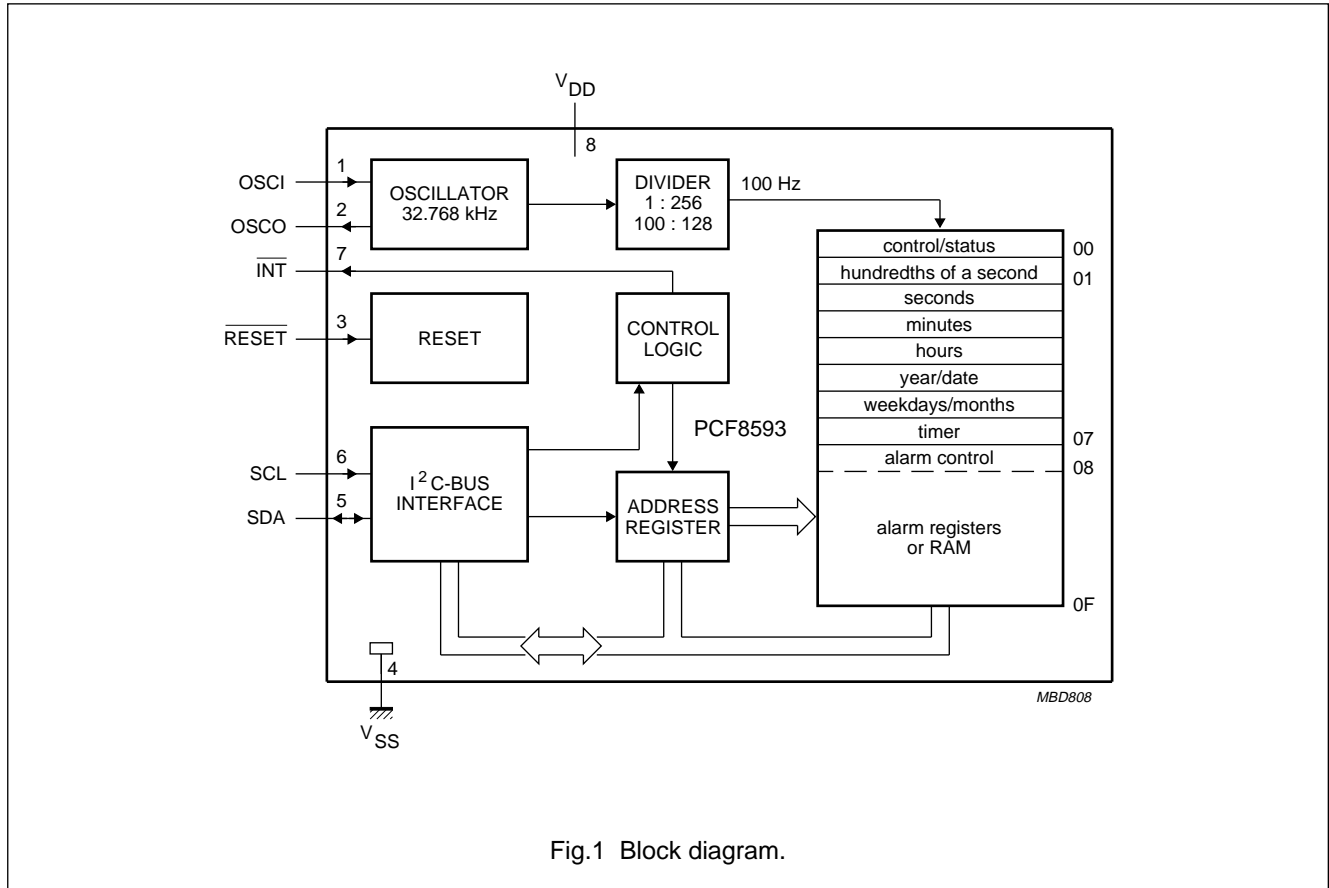
Fig.1 Block diagram.

PINNING

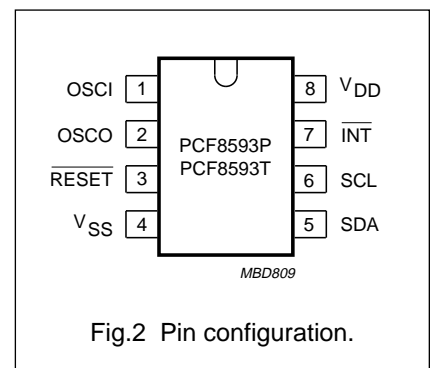| SYMBOL	PIN	DESCRIPTION
OSCI	1	oscillator input, 50 Hz or event-pulse input
OSCO	2	oscillator output
$\overline{RESET}$	3	reset input (active LOW)
V_{SS}	4	negative supply
SDA	5	serial data input/output
SCL	6	serial clock input
$\overline{INT}$	7	open drain interrupt output (active LOW)
V_{DD}	8	positive supply

Fig.2 Pin configuration.

Low power clock calendar   PCF8593

FUNCTIONAL DESCRIPTION

The PCF8593 contains sixteen 8-bit registers with an 8-bit auto-incrementing address register, an on-chip 32.768 kHz oscillator circuit, a frequency divider and a serial two-line bidirectional I²C-bus interface.

The first 8 registers (memory addresses 00 to 07) are designed as addressable 8-bit parallel registers. The first register (memory address 00) is used as a control/status register. The memory addresses 01 to 07 are used as counters for the clock function. The memory addresses 08 to 0F may be programmed as alarm registers or used as free RAM locations.

Counter function modes

When the control/status register is programmed, a 32.768 kHz clock mode, a 50 Hz clock mode or an event-counter mode can be selected.

In the clock modes the hundredths of a second, seconds, minutes, hours, date, month (four year calendar) and week day are stored in a BCD format. The timer register stores up to 99 days. The event counter mode is used to count pulses applied to the oscillator input (OSCO left open-circuit). The event counter stores up to 6 digits of data.

When one of the counters is read (memory locations 01 to 07), the contents of all counters are strobed into capture latches at the beginning of a read cycle. Therefore, faulty reading of the count during a carry condition is prevented.

When a counter is written, other counters are not affected.

Alarm function modes

By setting the alarm enable bit of the control/status register the alarm control register (address 08) is activated.

By setting the alarm control register a dated alarm, a daily alarm, a week day alarm or a timer alarm may be programmed. In the clock modes, the timer register (address 07) may be programmed to count hundredths of a second, seconds, minutes, hours or days. Days are counted when an alarm is not programmed.

Whenever an alarm event occurs the alarm flag of the control/status register is set. A timer alarm event will set the alarm flag and an overflow condition of the timer will set the timer flag. The open-drain interrupt output is switched on (active LOW) when the alarm or timer flag is set (enabled). The flags remain set until directly reset by a write operation.

When a timer function without any function is programmed the remaining alarm registers (addresses 09 to 0F) may be used as free RAM space.

Control/status register

The control/status register is defined as the memory location 00 with free access for reading and writing via the I²C-bus. All functions and options are controlled by the contents of the control/status register (see Fig.3).

Counter registers

In the clock modes 24 h or 12 h format can be selected by setting the most significant bit of the hours counter register. The format of the hours counter is shown in Fig.5.

The year and date are packed into memory location 05 (see Fig 6). The weekdays and months are packed into memory location 06 (see Fig.7). When reading these memory locations the year and weekdays are masked out when the mask flag of the control/status register is set. This allows the user to read the date and month count directly.

In the event-counter mode events are stored in BCD format. D5 is the most significant and D0 the least significant digit. The divider is by-passed.

In the different modes the counter registers are programmed and arranged as shown in Fig.4. Counter cycles are listed in Table 1.

MSB   **LSB**

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |

memory location 00

timer flag (50% duty factor seconds flag if alarm enable bit is 0)

alarm flag (50% duty factor minutes flag if alarm enable bit is 0)

alarm enable bit:
0   alarm disabled: flags toggle alarm control register disabled (memory locations 08 to 0F can be treated as RAM)
1   enable Alarm Control register (memory location 08 is the Alarm Control register)

mask flag:
0   read locations 05 to 06 unmasked
1   read date and month count directly

function mode :
00 clock mode 32.768 kHz
01 clock mode 50 Hz
10 event-counter mode
11   test modes

hold last count flag :
0 count
1 store and hold last count in capture latches

stop counting flag :
0 count pulses
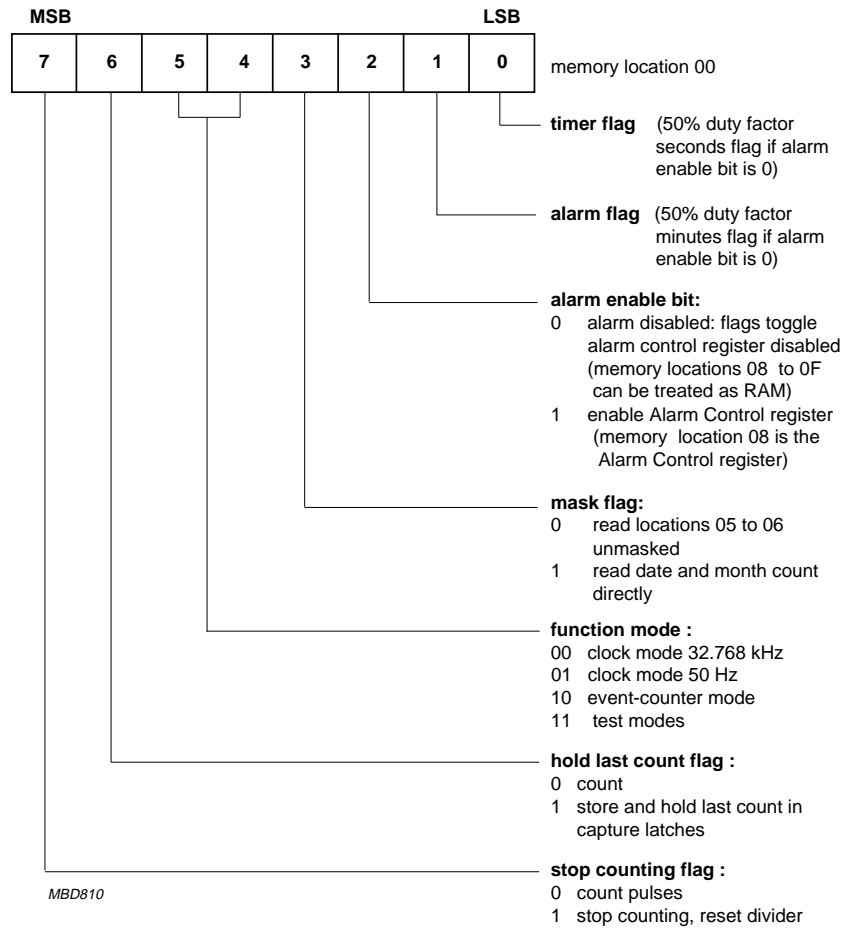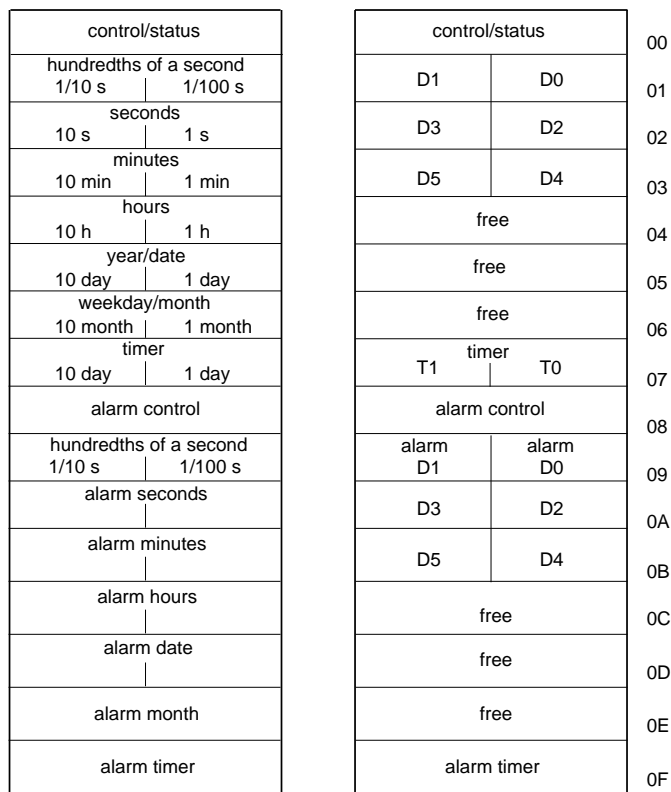1 stop counting, reset divider

MBD810

Fig.3 Control/status register.
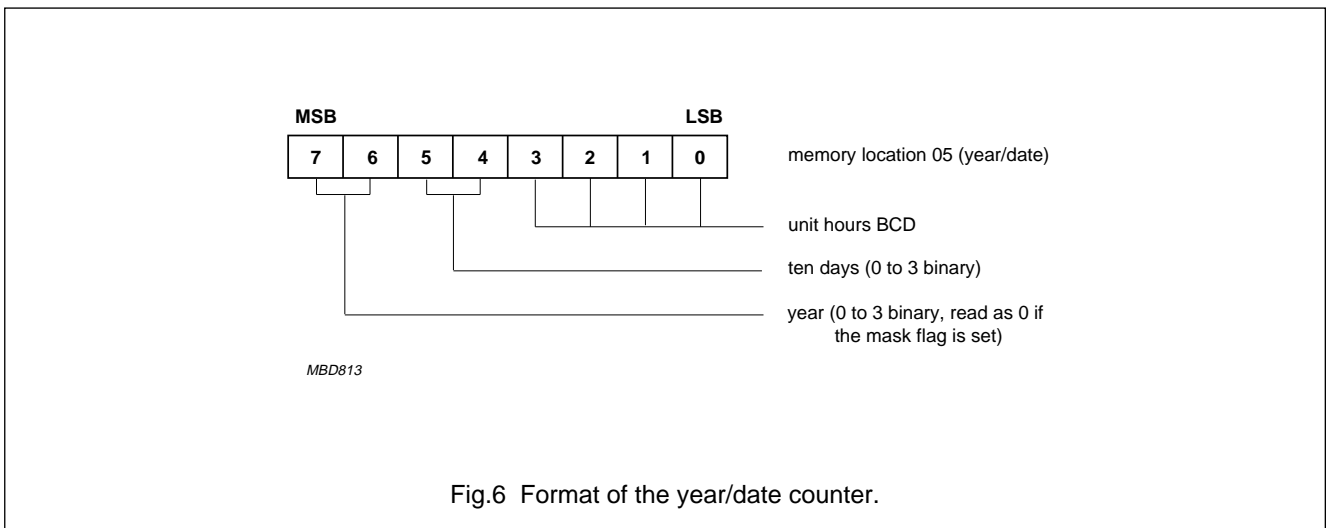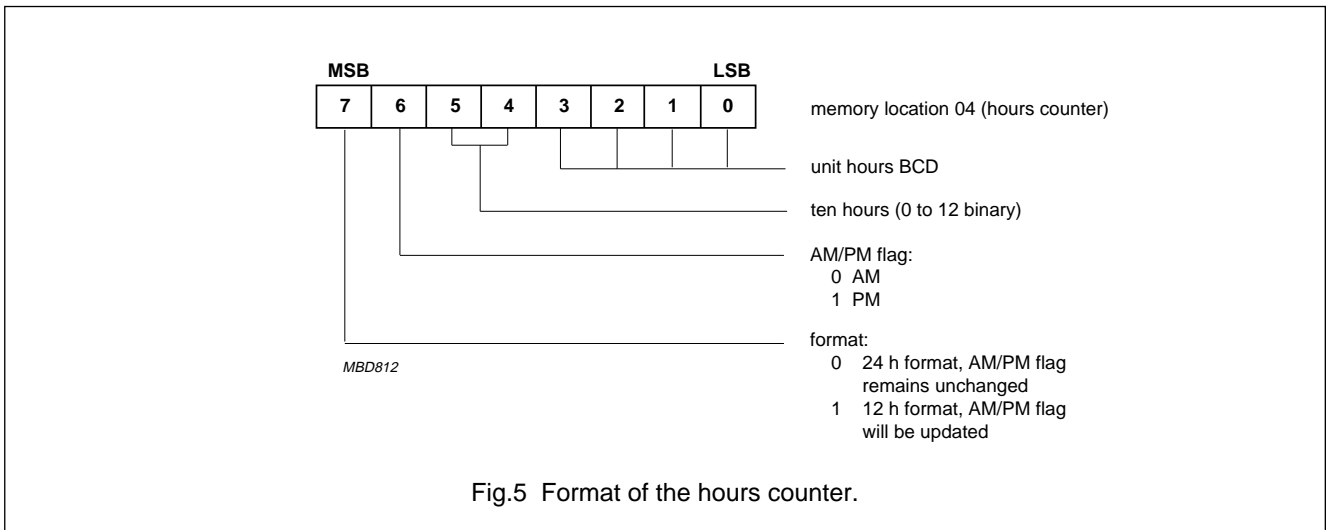
Low power clock calendar

PCF8593

CLOCK MODES			EVENT COUNTER		
control/status			control/status		00
hundredths of a second 1/10 s | 1/100 s			D1	D0	01
seconds 10 s | 1 s			D3	D2	02
minutes 10 min | 1 min			D5	D4	03
hours 10 h | 1 h			free		04
year/date 10 day | 1 day			free		05
weekday/month 10 month | 1 month			free		06
timer 10 day | 1 day			timer T1 | T0		07
alarm control			alarm control		08
hundredths of a second 1/10 s | 1/100 s			alarm D1	alarm D0	09
alarm seconds			D3	D2	0A
alarm minutes			D5	D4	0B
alarm hours			free		0C
alarm date			free		0D
alarm month			free		0E
alarm timer			alarm timer		0F

MBD811

Fig.4 Register arrangement.

Fig.5 Format of the hours counter.

Fig.6 Format of the year/date counter.

Fig.7 Format of the weekdays/months counter.
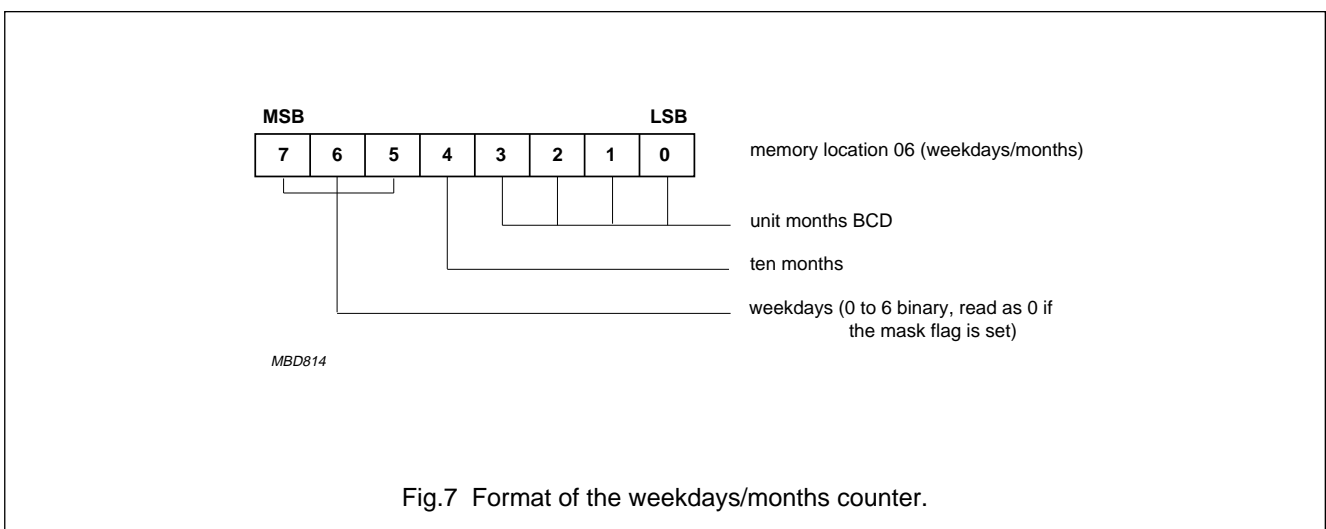
Low power clock calendar

PCF8593

Table 1 Cycle length of the time counters, clock modes.

UNIT	COUNTING CYCLE	CARRY TO NEXT UNIT	CONTENTS OF THE MONTH COUNTER
Hundredths of a second	00 to 99	99 to 00	–
Seconds	00 to 59	59 to 00	–
Minutes	00 to 59	59 to 00	–
Hours (24 h)	00 to 23	23 to 00	–
Hours (12 h)	12 AM	–	–
	01 AM to 11 AM	–	–
	12 PM	–	–
	01 PM to 11 PM	11 PM to 12 AM	–
Date	01 to 31	31 to 01	1, 3, 5, 7, 8, 10 and 12
	01 to 30	30 to 01	4, 6, 9 and 11
	01 to 29	29 to 01	2, year = 0
	01 to 28	28 to 01	2, year = 1, 2 and 3
Months	01 to 12	12 to 01	–
Year	0 to 3	–	–
Weekdays	0 to 6	6 to 0	–
Timer	00 to 99	no carry	–

Alarm control register

When the alarm enable bit of the control/status register is set (address 00, bit 2) the alarm control register (address 08) is activated. All alarm, timer, and interrupt output functions are controlled by the contents of the alarm control register (see Fig.8).

Alarm registers

All alarm registers are allocated with a constant address offset of hexadecimal 08 to the corresponding counter registers (see Fig.4; Register arrangement).

An alarm signal is generated when the contents of the alarm registers matches bit-by-bit the contents of the involved counter registers. The year and weekday bits are ignored in a dated alarm. A daily alarm ignores the month and date bits. When a weekday alarm is selected, the contents of the alarm weekday/month register will select the weekdays on which an alarm is activated (see Fig.9).

Remark: in the 12 h mode, bits 6 and 7 of the alarm hours register must be the same as the hours counter.
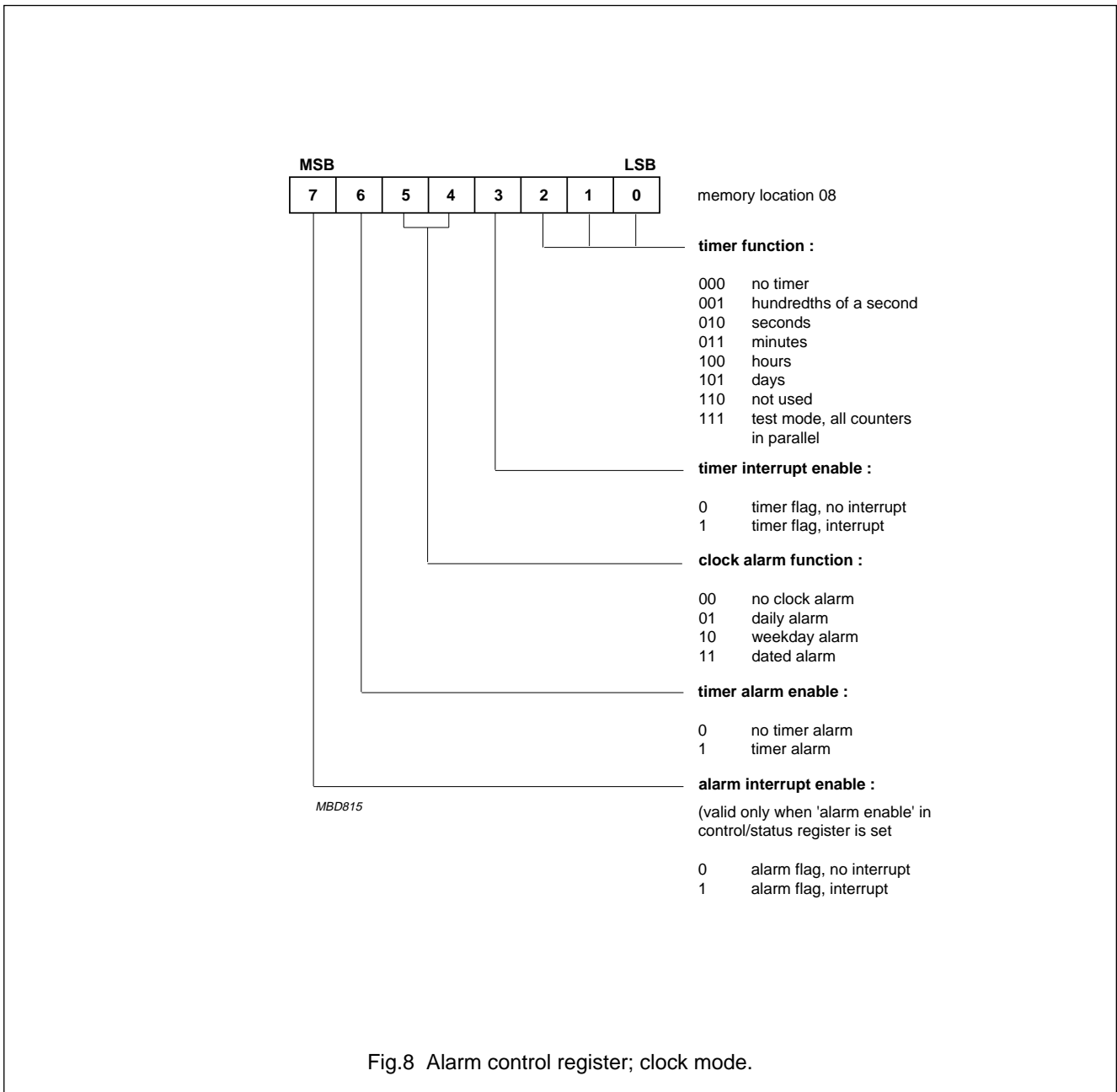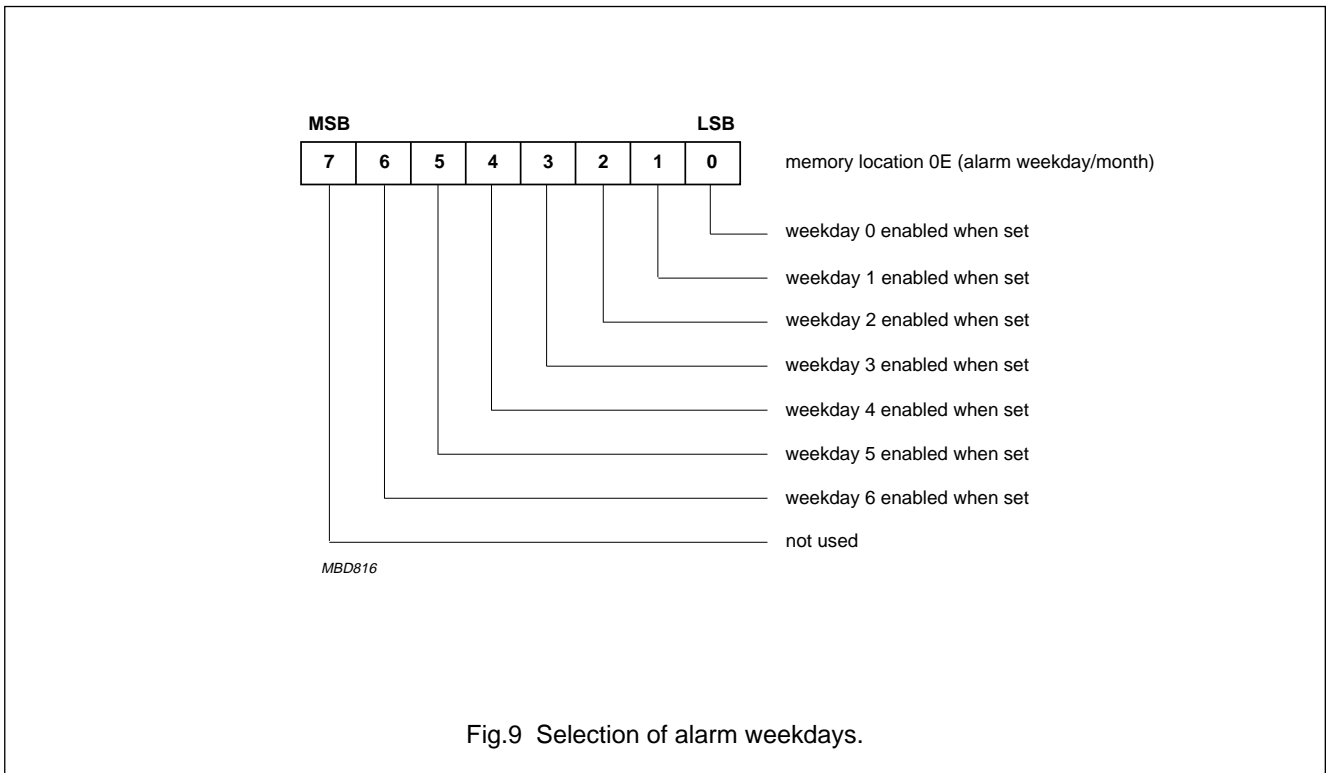
MSB   LSB

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 |

memory location 08

timer function :

000 no timer
001 hundredths of a second
010 seconds
011 minutes
100 hours
101 days
110 not used
111 test mode, all counters
   in parallel

timer interrupt enable :

0 timer flag, no interrupt
1 timer flag, interrupt

clock alarm function :

00 no clock alarm
01 daily alarm
10 weekday alarm
11 dated alarm

timer alarm enable :

0 no timer alarm
1 timer alarm

alarm interrupt enable :

(valid only when 'alarm enable' in
control/status register is set

0 alarm flag, no interrupt
1 alarm flag, interrupt

MBD815

Fig.8 Alarm control register; clock mode.

Low power clock calendar

PCF8593

Fig.9 Selection of alarm weekdays.

Timer

The timer (location 07) is enabled by setting the control/status register = XX0X X1XX. The timer counts up from 0 (or a programmed value) to 99. On overflow, the timer resets to 0. The timer flag (LSB of control/status register) is set on overflow of the timer. This flag must be reset by software. The inverted value of this flag can be transferred to the external interrupt by setting bit 3 of the alarm control register.

Additionally, a timer alarm can be programmed by setting the timer alarm enable (bit 6 of the alarm control register). When the value of the timer equals a pre-programmed value in the alarm timer register (location 0F), the alarm flag is set (bit 1 of the control/status register). The inverted value of the alarm flag can be transferred to the external interrupt by enabling the alarm interrupt (bit 6 of the alarm control register).

Resolution of the timer is programmed via the 3 LSBs of the alarm control register (see Fig.11; Alarm and timer Interrupt logic diagram).

Event counter mode

Event counter mode is selected by bits 4 and 5 which are logic 1, 0 in the control/status register. The event counter mode is used to count pulses externally applied to the oscillator input (OSCO left open-circuit). The event counter stores up to 6 digits of data, which are stored as 6 hexadecimal values located in locations 1, 2, and 3. Thus, up to 1 million events may be recorded.

An event counter alarm occurs when the event counter registers match the value programmed in locations 9, A, and B, and the event alarm is enabled (bits 4 and 5 which are logic 0, 1 in the alarm control register). In this event, the alarm flag (bit 1 of the control/status register) is set. The inverted value of this flag can be transferred to the interrupt pin (pin 7) by setting the alarm interrupt enable in the alarm control register. In this mode, the timer (location 07) increments once for every one, one-hundred, ten thousand, or 1 million events, depending on the value programmed in bits 0,1 and 2 of the alarm control register. In all other events, the timer functions are as in the clock mode.

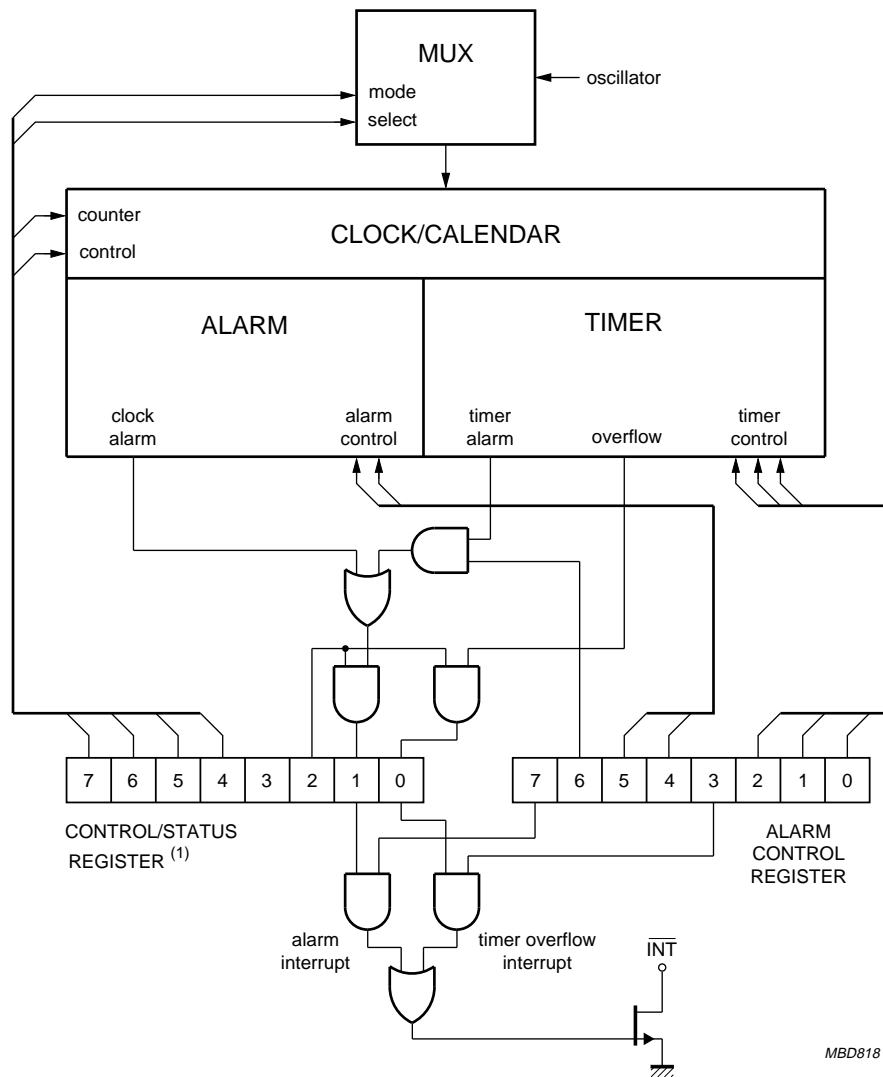# Low power clock calendar

PCF8593

Fig.10 Alarm control register; event-counter mode.

The figure shows memory location 08 with bits labeled MSB 7 6 5 4 3 2 1 0 LSB, with the following breakdown:

timer function :

000   no timer
001   units
010   100
011   10 000
100   1 000 000
101   not allowed
110   not allowed
111   test mode, all counters
       in parallel

timer interrupt enable :

0   timer flag, no interrupt
1   timer flag, interrupt

clock alarm function :

00   no event alarm
01   event alarm
10   not allowed
11   not allowed

timer alarm enable :

0   no timer alarm
1   timer alarm

alarm interrupt enable :

0   alarm flag, no interrupt
1   alarm flag, interrupt

MBD817

Interrupt output

The conditions for activating the open-drain n-channel interrupt output $\overline{INT}$ (active LOW) are determined by appropriate programming of the alarm control register. These conditions are clock alarm, timer alarm, timer overflow, and event counter alarm. An interrupt occurs when the alarm flag or the timer flag is set, and the corresponding interrupt is enabled. In all events, the interrupt is cleared only by software resetting of the flag which initiated the interrupt.

In the clock mode, if the alarm enable is not activated (alarm enable bit of control/status register is logic 0), the interrupt output toggles at 1 Hz with a 50% duty cycle (may be used for calibration). The OFF voltage of the interrupt output may exceed the supply voltage, up to a maximum of 6.0 V. A logic diagram of the interrupt output is shown in Fig.11.

Low power clock calendar

PCF8593

(1) If the alarm enable bit of the control/status register is reset (logic 0), a 1 Hz signal can be observed on the interrupt pin $\overline{INT}$.

Fig.11 Alarm and timer interrupt logic diagram.

Oscillator and divider

A 32.768 kHz quartz crystal has to be connected to OSCI (pin 1) and OSCO (pin 2). A trimmer capacitor between OSCI and V_{DD} is used for tuning the oscillator (see Chapter "Application information" ; Section "Quartz frequency adjustment"). A 100 Hz clock signal is derived from the quartz oscillator for the clock counters.

In the 50 Hz clock mode or event-counter mode the oscillator is disabled and the oscillator input is switched to a high-impedance state. This allows the user to feed the 50 Hz reference frequency or an external high-speed event signal into the input OSCI.

DESIGNING

When designing the printed-circuit board layout, keep the oscillator components as close to the IC package as possible, and keep all other signal lines as far away as possible. In applications involving tight packing of components, shielding of the oscillator may be necessary. AC coupling of extraneous signals can introduce oscillator inaccuracy.

Initialization (see Fig.12)

Note that immediately following power-on, all internal registers are undefined and, following a $\overline{\text{RESET}}$ pulse on pin 3, must be defined via software. Attention should be paid to the possibility that the device may be initially in event-counter mode, in which event the oscillator will not operate. Over-ride can be achieved via software.

Reset is accomplished by applying an external $\overline{\text{RESET}}$ pulse (active LOW) at pin 3. When reset occurs the I²C-bus interface is reset. The control/status register and all clock counters are not affected by $\overline{\text{RESET}}$. $\overline{\text{RESET}}$ must return HIGH during device operation.

To avoid overload of the internal diode by falling V_{DD}, an external diode should be added in parallel to R_R if $C_R \geq 0.2$ μF. Note that RC must be evaluated with the actual V_{DD} of the application, as their value will be V_{DD} rise-time dependent.

Fig.12 RC reset.
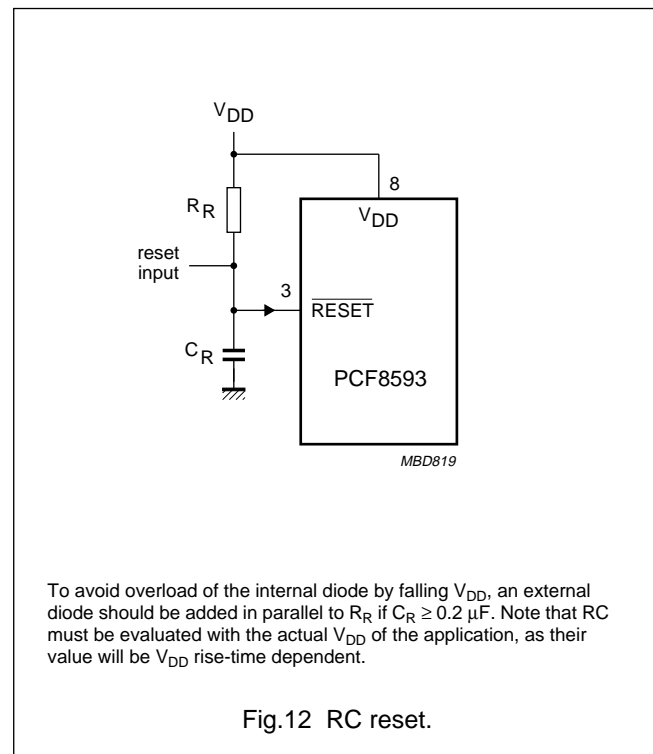
An RC combination can also be utilized to provide a power-on $\overline{\text{RESET}}$ signal at pin 3. In this event, the values of the RC must fulfil the following relationship to guarantee power-on reset (see Fig.12).

$\overline{\text{RESET}}$ input must be ≤0.3V_{DD} when V_{DD} reaches V_{DDmin} (or higher).

It is recommended to set the stop counting flag of the control/status register before loading the actual time into the counters. Loading of illegal states may lead to a temporary clock malfunction.

CHARACTERISTICS OF THE I^{2}C-BUS

The I^{2}C-bus is for bidirectional, two-line communication between different ICs or modules. The two lines are a serial data line (SDA) and a serial clock line (SCL). Both lines must be connected to a positive supply via a pull-up resistor. Data transfer may be initiated only when the bus is not busy.

Bit transfer

One data bit is transferred during each clock pulse. The data on the SDA line must remain stable during the HIGH period of the clock pulse as changes in the data line at this time will be interpreted as a control signal.

Fig.13 Bit transfer.
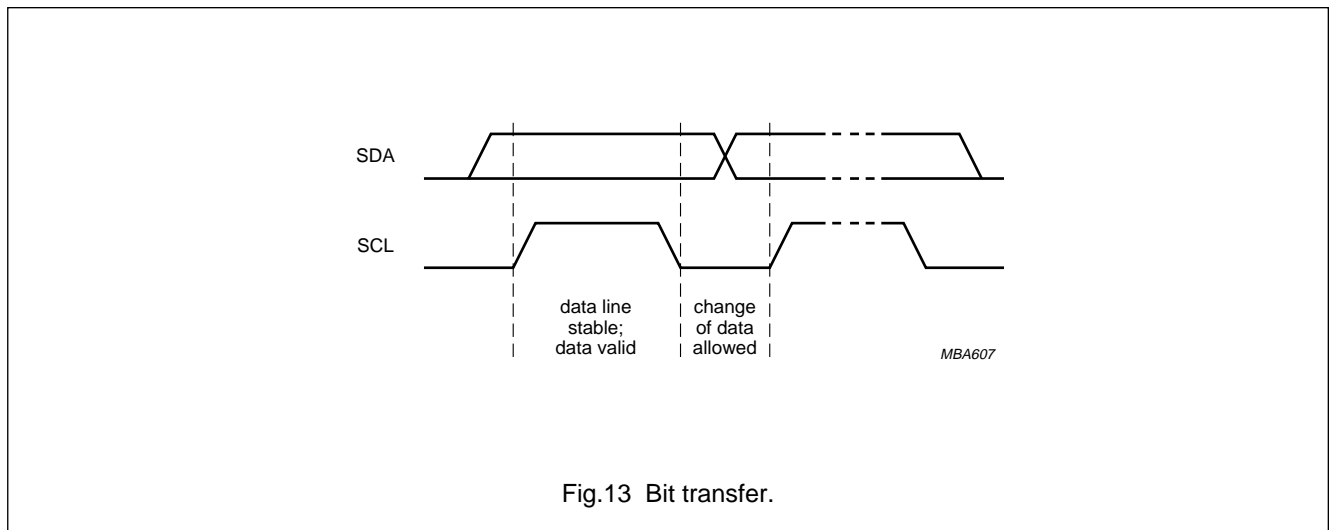
Start and stop conditions

Both data and clock lines remain HIGH when the bus is not busy. A HIGH-to-LOW transition of the data line, while the clock is HIGH is defined as the start condition (S). A LOW-to-HIGH transition of the data line while the clock is HIGH is defined as the stop condition (P).

Fig.14 Definition of start and stop conditions.
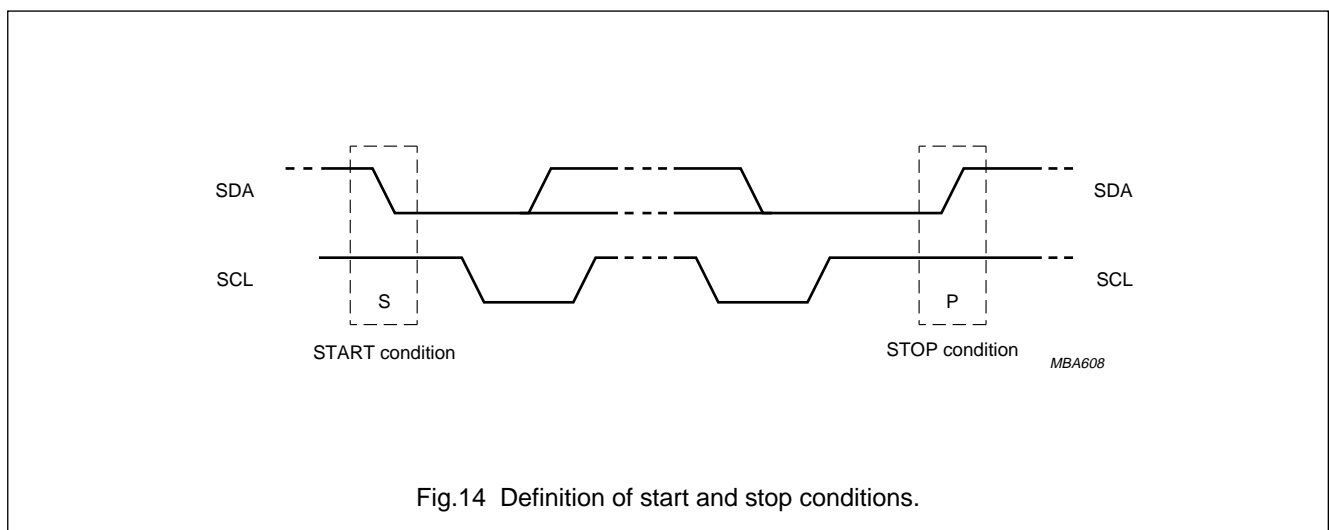
System configuration

A device generating a message is a 'transmitter', a device receiving a message is the 'receiver'. The device that controls the message is the 'master' and the devices which are controlled by the master are the 'slaves'.
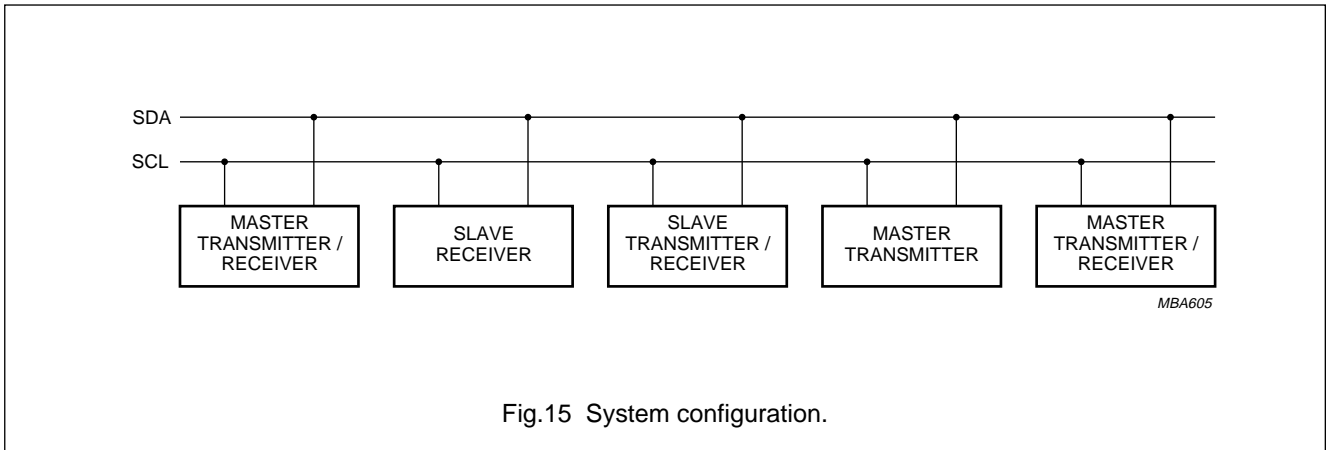

Fig.15 System configuration.

Acknowledge

The number of data bytes transferred between the start and stop conditions from transmitter to receiver is unlimited. Each byte of eight bits is followed by an acknowledge bit. The acknowledge bit is a HIGH level signal put on the bus by the transmitter during which time the master generates an extra acknowledge related clock pulse. A slave receiver which is addressed must generate an acknowledge after the reception of each byte. Also a master receiver must generate an acknowledge after the reception of each byte that has been clocked out of the slave transmitter.

The device that acknowledges must pull down the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during the HIGH period of the acknowledge related clock pulse (set-up and hold times must be taken into consideration). A master receiver must signal an end of data to the transmitter by not generating an acknowledge on the last byte that has been clocked out of the slave. In this event the transmitter must leave the data line HIGH to enable the master to generate a stop condition.
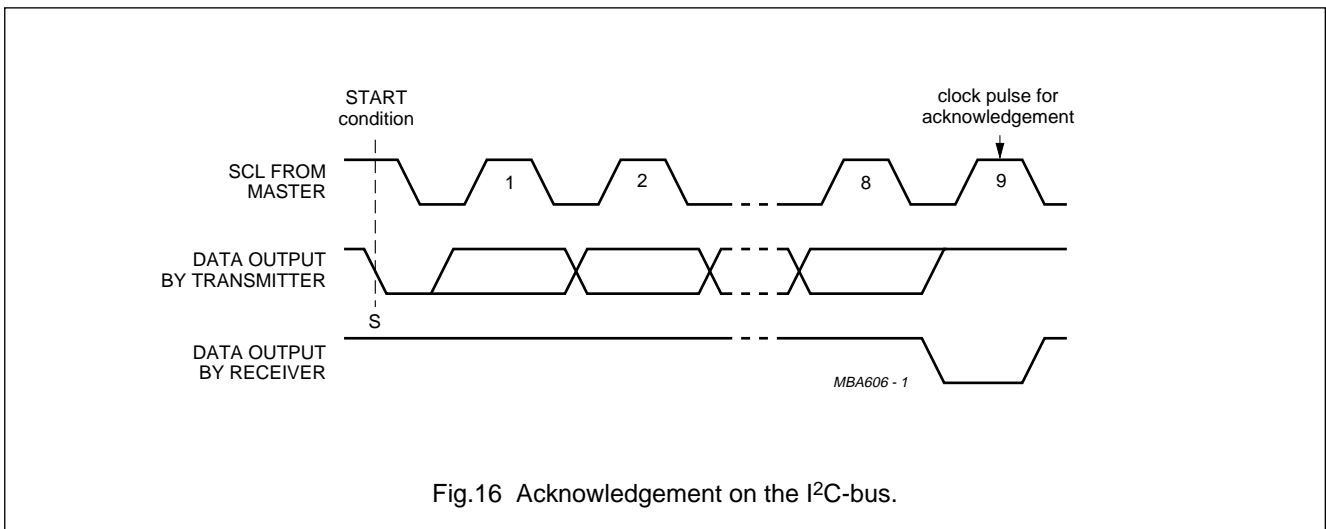

Fig.16 Acknowledgement on the I^{2}C-bus.

Low power clock calendar

PCF8593

I²C-bus protocol

Before any data is transmitted on the I²C-bus, the device which should respond is addressed first. The addressing is always carried out with the first byte transmitted after the start procedure. The I²C-bus configuration for the different PCF8593 READ and WRITE cycles is shown in Figs 17, 18 and 19.
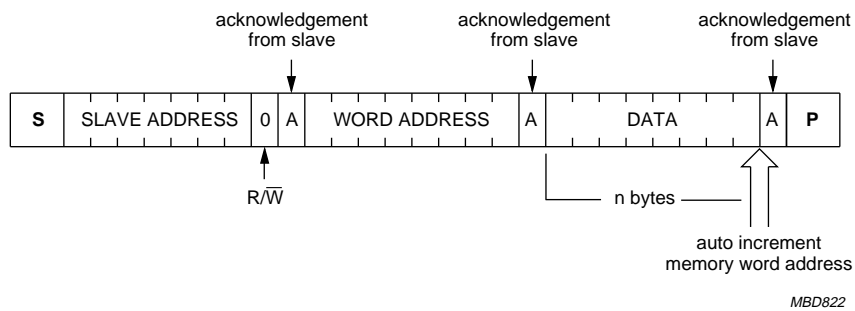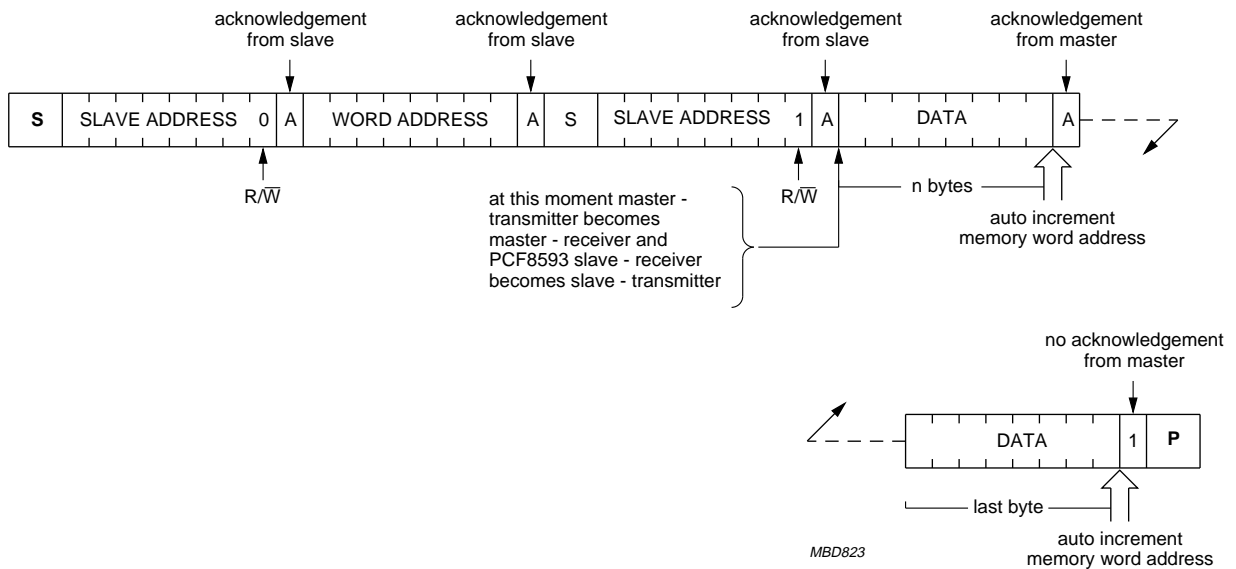

Fig.17 Master transmits to slave receiver (WRITE) mode.

Fig.18 Master reads after setting word address (write word address; READ data).
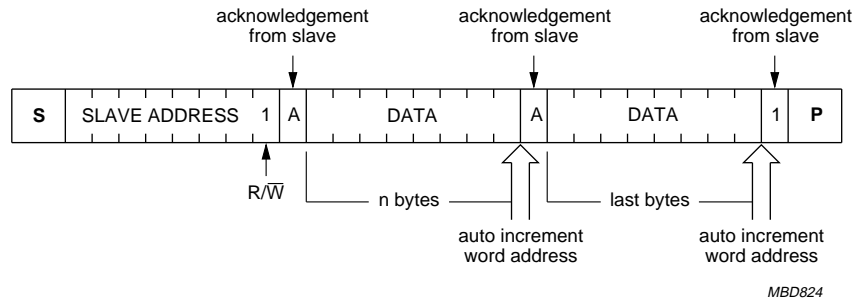
Fig.19 Master reads slave immediately after first byte (READ mode).

Low power clock calendar

PCF8593

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V_{DD}	supply voltage (pin 8)	−0.8	+7.0	V
I_{DD}	supply current (pin 8)	–	50	mA
I_{SS}	supply current (pin 4)	–	50	mA
V_I	input voltage	−0.8	V_{DD} + 0.8	V
I_I	DC input current	–	10	mA
I_O	DC output current	–	10	mA
P_{tot}	total power dissipation per package	–	300	mW
P_O	power dissipation per output	–	50	mW
T_{amb}	operating ambient temperature	−40	+85	°C
T_{stg}	storage temperature	−65	+150	°C

HANDLING

Inputs and outputs are protected against electrostatic discharge in normal handling. However, to be totally safe, it is desirable to take precautions appropriate to handling MOS devices (see *"Handling MOS Devices"*).

DC CHARACTERISTICS

V_{DD} = 2.5 to 6.0 V; V_{SS} = 0 V; T_{amb} = −40 to +85 °C; f_{osc} = 32 kHz; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.[1]	MAX.	UNIT
Supply						
V_{DD}	supply voltage operating mode	I^{2}C-bus active	2.5	–	6.0	V
		I^{2}C-bus inactive	1.0	–	6.0	V
V_{DDosc}	quartz oscillator supply voltage	T_{amb} = 0 to 70 °C; note 2	1.0	–	6.0	V
		T_{amb} = −40 to 85 °C; note 2	1.2	–	6.0	V
I_{DD}	supply current operating mode	f_{scl} = 100 kHz; clock mode; note 3	–	–	200	µA
I_{DD}	supply current clock mode	f_{scl} = 0 Hz; V_{DD} = 2 V; inputs at V_{DD} or V_{SS}	–	1.0	8.0	µA
		f_{scl} = 0 Hz; V_{DD} = 5 V; inputs at V_{DD} or V_{SS}	–	4.0	15	µA
SDA, SCL, $\overline{INT}$ and RESET						
V_{IL}	LOW level input voltage		0	–	$0.3V_{DD}$	V
V_{IH}	HIGH level input voltage		$0.7V_{DD}$	–	V_{DD}	V
I_{OL}	LOW level output current	V_{OL} = 0.4 V	3	–	–	mA
I_{LI}	input leakage current	V_I = V_{DD} or V_{SS}	−1	–	+1	µA
C_I	input capacitance	note 4	–	–	7	pF

Low power clock calendar

PCF8593

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.[1]	MAX.	UNIT
OSCI and RESET						
I_{LI}	input leakage current	$V_I = V_{DD}$ or V_{SS}	−250	–	+250	nA
INT						
I_{OL}	LOW level output current	$V_{OL} = 0.4$ V	1	–	–	mA
I_{LI}	input leakage current	$V_I = V_{DD}$ or V_{SS}	−1	–	+1	μA
SCL						
C_I	input capacitance	note 4	–	–	7	pF
I_{LI}	input leakage current	$V_I = V_{DD}$ or V_{SS}	−1	–	+1	μA

Notes

1. Typical values measured at 25 °C.

2. When powering up the device, V_{DD} must exceed the specified minimum value by 300 mV to guarantee correct start-up of the oscillator.

3. Event counter mode; supply current dependent upon input frequency.

4. Tested on sample basis.

$f_{SCL} = 32$ kHz; $T_{amb} = 25$ °C.

Fig.20 Typical supply current in clock mode as a function of supply voltage.
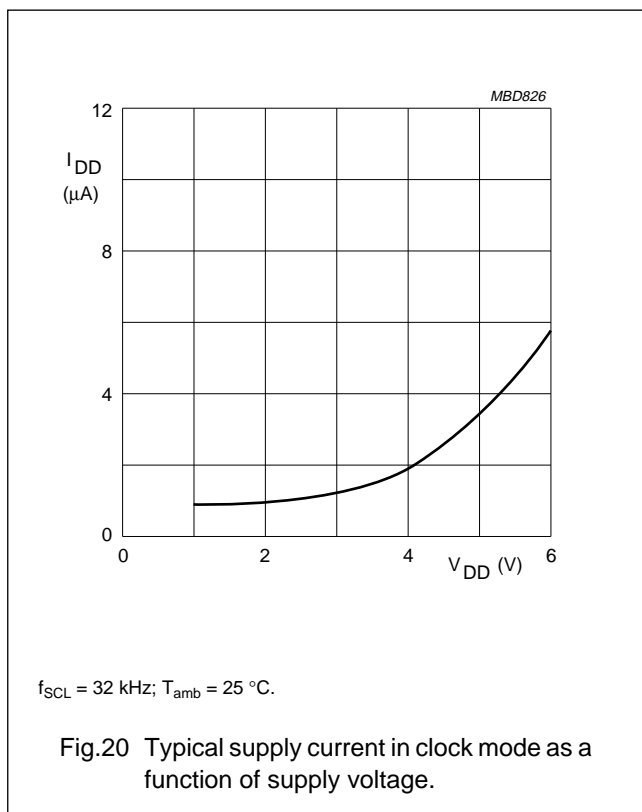
Low power clock calendar PCF8593

AC CHARACTERISTICS

V_{DD} = 2.5 to 6.0 V; V_{SS} = 0 V; T_{amb} = −40 to +85 °C; unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Oscillator						
C_{osc}	integrated oscillator capacitance		20	25	30	pF
Δf_{osc}	oscillator stability	for ΔV_{DD} = 100 mV; T_{amb} = 25 °C; V_{DD} = 1.5 V	–	2×10^{-7}	–	
f_i	input frequency	note 1	–	–	1	MHz
Quartz crystal parameters (f = 32.768 kHz)						
R_s	series resistance		–	–	40	kΩ
C_L	parallel load capacitance		–	10	–	pF
C_T	trimmer capacitance		5	–	25	pF
I²C-bus timing (see Fig.21; notes 2 and 3)						
f_{SCL}	SCL clock frequency		–	–	100	kHz
t_{SP}	tolerable spike width on bus		–	–	100	ns
t_{BUF}	bus free time		4.7	–	–	μs
$t_{SU;STA}$	start condition set-up time		4.7	–	–	μs
$t_{HD;STA}$	start condition hold time		4.0	–	–	μs
t_{LOW}	SCL LOW time		4.7	–	–	μs
t_{HIGH}	SCL HIGH time		4.0	–	–	μs
t_r	SCL and SDA rise time		–	–	1.0	μs
t_f	SCL and SDA fall time		–	–	0.3	μs
$t_{SU;DAT}$	data set-up time		250	–	–	ns
$t_{HD;DAT}$	data hold time		0	–	–	ns
$t_{VD;DAT}$	SCL LOW to data out valid		–	–	3.4	μs
$t_{SU;STO}$	stop condition set-up time		4.0	–	–	μs

Notes

1. Event counter mode only.

2. All timing values are valid within the operating supply voltage and ambient temperature range and reference to V_{IL} and V_{IH} with an input voltage swing of V_{SS} to V_{DD}.

3. A detailed description of the I²C-bus specification, with applications, is given in brochure *"The I²C-bus and how to use it"*. This brochure may be ordered using the code 9398 393 40011.

Low power clock calendar

PCF8593

Fig.21 I²C-bus timing diagram; rise and fall times refer to V_{IL} and V_{IH}.
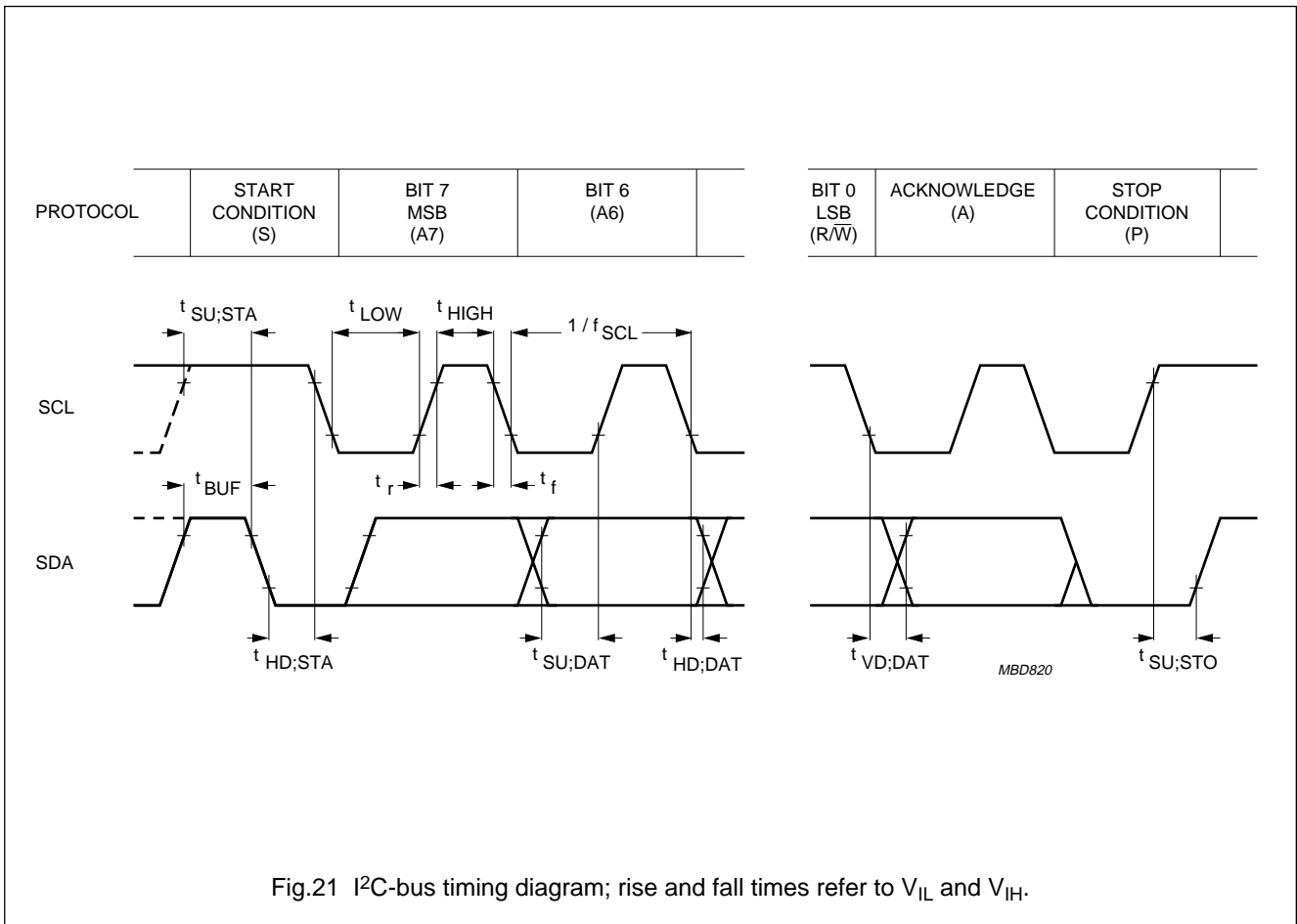
Low power clock calendar

PCF8593

APPLICATION INFORMATION

Quartz frequency adjustment

METHOD 1: FIXED OSCI CAPACITOR

By evaluating the average capacitance necessary for the application layout a fixed capacitor can be used. The frequency is best measured via the 1 Hz signal which can be programmed to occur at the interrupt output (pin 7). The frequency tolerance depends on the quartz crystal tolerance, the capacitor tolerance and the device-to-device tolerance (on average $\pm 5 \times 10^{-6}$). Average deviations of ± 5 minutes per year can be achieved.

METHOD 2: OSCI TRIMMER

Using the alarm function (via the I^{2}C-bus) a signal faster than 1 Hz can be generated at the interrupt output for fast setting of a trimmer.

Procedure:

• Power-on

• Apply $\overline{\text{RESET}}$

• Initialization (alarm functions).

Routine:
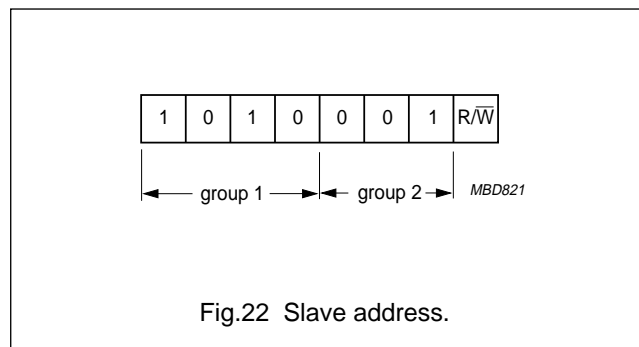
• Set clock to time T and set alarm to time T + ΔT

• At time T + ΔT (interrupt) repeat routine.

METHOD 3: DIRECT OUTPUT

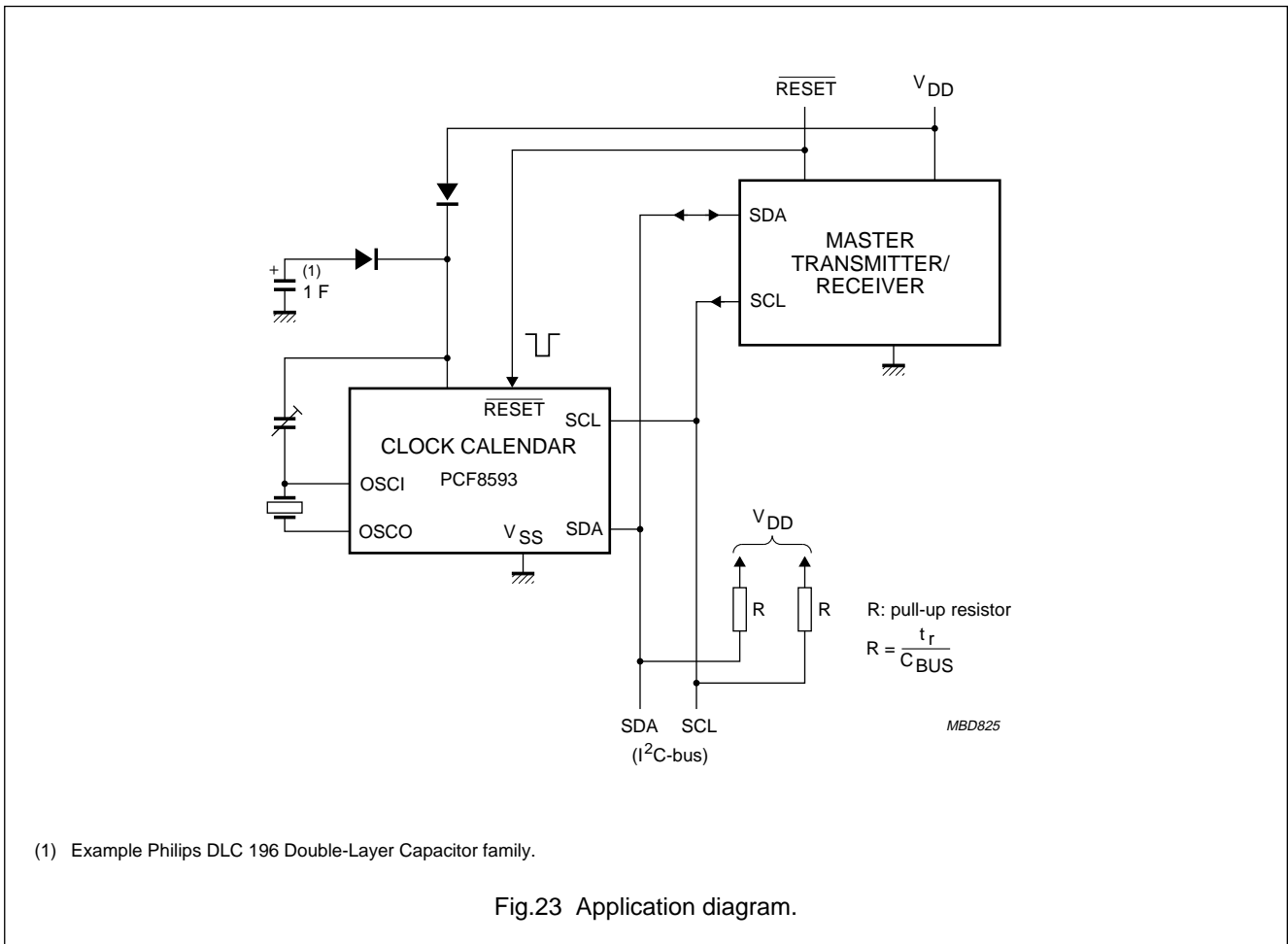Direct measurement of oscillator output (accounting for test probe capacitance).

Slave address

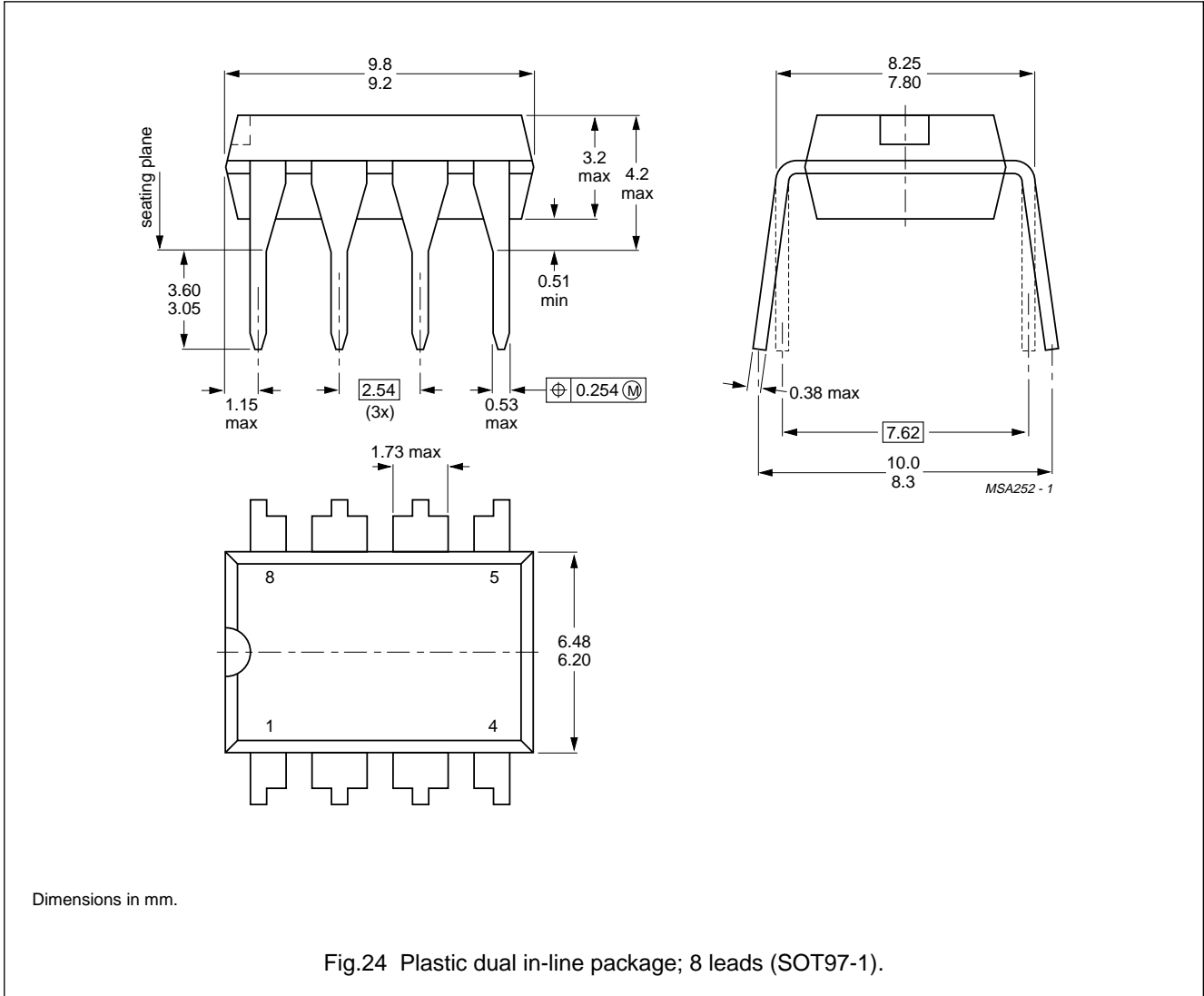The PCF8593 has an internally fixed I^{2}C-bus slave address.

Fig.22 Slave address.

(1) Example Philips DLC 196 Double-Layer Capacitor family.

Fig.23 Application diagram.

Low power clock calendar

PCF8593

PACKAGE OUTLINES

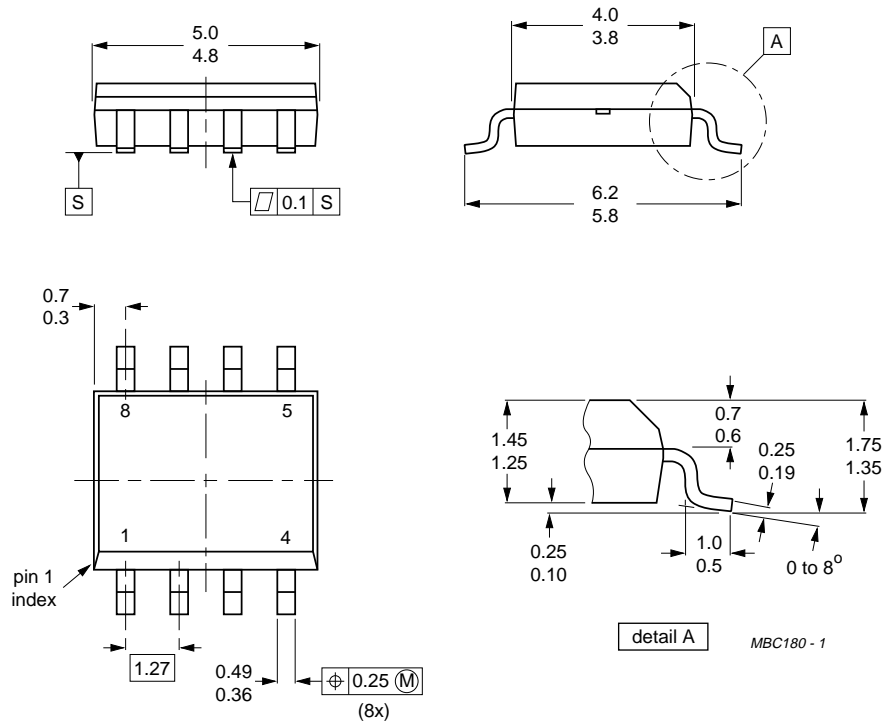Dimensions in mm.

Fig.24 Plastic dual in-line package; 8 leads (SOT97-1).

Low power clock calendar

PCF8593

Dimensions in mm.

Fig.25 Plastic small outline package; 8 leads (SOT96-1; SO8).

Low power clock calendar

PCF8593

SOLDERING

Plastic dual in-line packages

BY DIP OR WAVE

The maximum permissible temperature of the solder is 260 °C; this temperature must not be in contact with the joint for more than 5 s. The total contact time of successive solder waves must not exceed 5 s.

The device may be mounted up to the seating plane, but the temperature of the plastic body must not exceed the specified storage maximum. If the printed-circuit board has been pre-heated, forced cooling may be necessary immediately after soldering to keep the temperature within the permissible limit.

REPAIRING SOLDERED JOINTS

Apply a low-voltage soldering iron below the seating plane (or not more than 2 mm above it). If its temperature is below 300 °C, it must not be in contact for more than 10 s; if between 300 and 400 °C, for not more than 5 s.

Plastic small-outline packages

BY WAVE

During placement and before soldering, the component must be fixed with a droplet of adhesive. After curing the adhesive, the component can be soldered. The adhesive can be applied by screen printing, pin transfer or syringe dispensing.

Maximum permissible solder temperature is 260 °C, and maximum duration of package immersion in solder bath is 10 s, if allowed to cool to less than 150 °C within 6 s. Typical dwell time is 4 s at 250 °C.

A modified wave soldering technique is recommended using two solder waves (dual-wave), in which a turbulent wave with high upward pressure is followed by a smooth laminar wave. Using a mildly-activated flux eliminates the need for removal of corrosive residues in most applications.

BY SOLDER PASTE REFLOW

Reflow soldering requires the solder paste (a suspension of fine solder particles, flux and binding agent) to be applied to the substrate by screen printing, stencilling or pressure-syringe dispensing before device placement.

Several techniques exist for reflowing; for example, thermal conduction by heated belt, infrared, and vapour-phase reflow. Dwell times vary between 50 and 300 s according to method. Typical reflow temperatures range from 215 to 250 °C.

Preheating is necessary to dry the paste and evaporate the binding agent. Preheating duration: 45 min at 45 °C.

REPAIRING SOLDERED JOINTS (BY HAND-HELD SOLDERING IRON OR PULSE-HEATED SOLDER TOOL)

Fix the component by first soldering two, diagonally opposite, end pins. Apply the heating tool to the flat part of the pin only. Contact time must be limited to 10 s at up to 300 °C. When using proper tools, all other pins can be soldered in one operation within 2 to 5 s at between 270 and 320 °C. (Pulse-heated soldering is not recommended for SO packages.)

For pulse-heated solder tool (resistance) soldering of VSO packages, solder is applied to the substrate by dipping or by an extra thick tin/lead plating before package placement.

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.

PURCHASE OF PHILIPS I²C COMPONENTS

Purchase of Philips I²C components conveys a license under the Philips' I²C patent to use the components in the I²C system provided the system conforms to the I²C specification defined by Philips. This specification can be ordered using the code 9398 393 40011.